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Complete if Known Substitute for form 1449A/B/PTO Application Number 10/706,209-Conf. #5999 INFORMATION DISCLOSURE November 12, 2003 Filing Date Tieyu Zheng STATEMENT BY APPLICANT First Named Inventor 2874 Art Unit (Use as many sheets as necessary) Examiner Name Not Yet Assigned 30320/15635X Attorney Docket Number Sheet 1

	U.S. PATENT DOCUMENTS						
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NON PATENT LITERATURE DOCUMENTS							
Examiner Initials	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T²				

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Examiner Signature	/Hemang Sanghavi/	Date Considered	03/31/2007

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U.S. Department of Commerce Patent and Trademark Office Atty. Docket No. 30320/15635X Serial No. 10/706,209

Applicant Tieyu Zheng

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